

L Number	Hits	Search Text	DB	Time stamp
1	662	(driver with substrate) same lcd	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 12:56
2	7	((driver with substrate) same lcd) and 349/158	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:00
3	32	((driver with substrate) same lcd) and (flip with chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:05
4	7121	bonding adj area	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:38
5	11822	(bonding adj area) and (349/). ccls	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:08
6	8	(bonding adj area) and 349/151	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:38
7	7	(bonding adj area) and 349/152	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:21
8	8	(bonding adj area) and 349/151	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:22
9	13	(bonding adj area) and 349/150	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:45
10	16	(bonding adj area) and 349/149	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:26
11	1	(bonding adj area) same (driver adj chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:39
12	24	(bonding adj area) and (driver adj chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:40
13	5	(bonding adj area) and 349/158	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:48
14	3	(bonding adj area) and 349/139	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:53
15	2	(bonding adj area) and 349/84	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:53
16	4	(bonding adj area) and 349/187	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/06 13:54

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